

# **FS50UM-3**

High-Speed Switching Use Nch Power MOS FET

REJ03G1424-0200

(Previous: MEJ02G0118-0101)

Rev.2.00 Aug 07, 2006

## **Features**

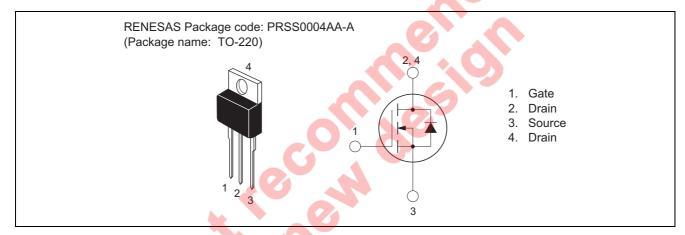
Drive voltage : 10 VV<sub>DSS</sub> : 150 V

•  $r_{DS(ON) (max)}$ : 31 m $\Omega$ 

• I<sub>D</sub>: 50 A

• Integrated Fast Recovery Diode (TYP.): 130 ns

### **Outline**



## **Applications**

Motor control, Lamp control, Solenoid control, DC-DC converters, etc.

## **Maximum Ratings**

 $(Tc = 25^{\circ}C)$ 

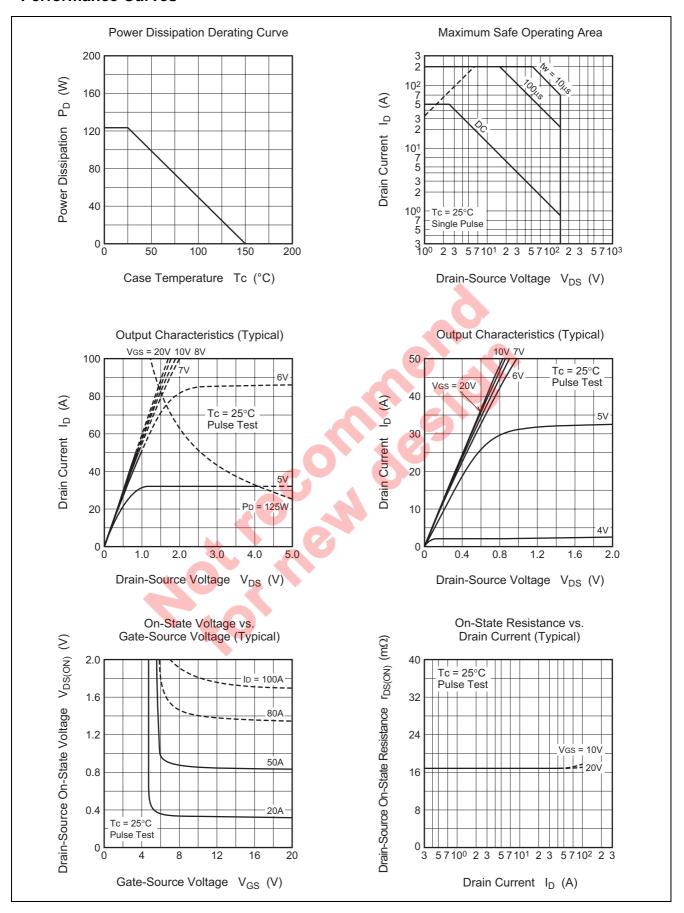
Parameter	Symbol	Ratings	Unit	Conditions
Drain-source voltage	$V_{DSS}$	150	V	V <sub>GS</sub> = 0 V
Gate-source voltage	$V_{GSS}$	±20	V	$V_{DS} = 0 V$
Drain current	I <sub>D</sub>	50	Α	
Drain current (Pulsed)	I <sub>DM</sub>	200	Α	
Avalanche drain current (Pulsed)	I <sub>DA</sub>	50	Α	L = 100 μH
Source current	Is	50	Α	
Source current (Pulsed)	I <sub>SM</sub>	200	Α	
Maximum power dissipation	$P_D$	125	W	
Channel temperature	Tch	- 55 to +150	°C	
Storage temperature	Tstg	- 55 to +150	°C	
Mass	_	2.0	g	Typical value

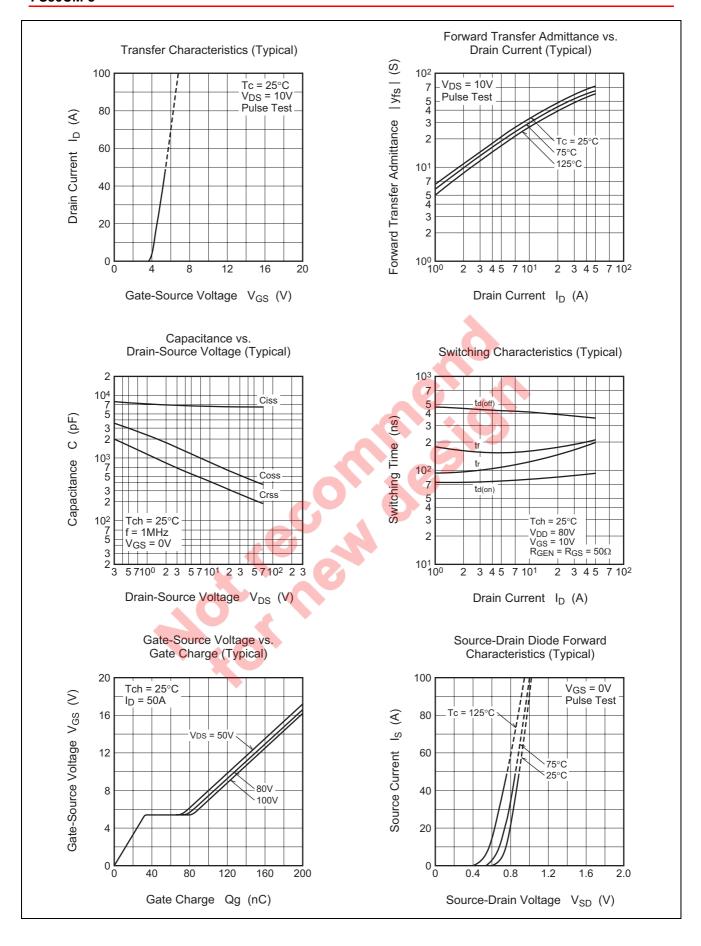
## **Electrical Characteristics**

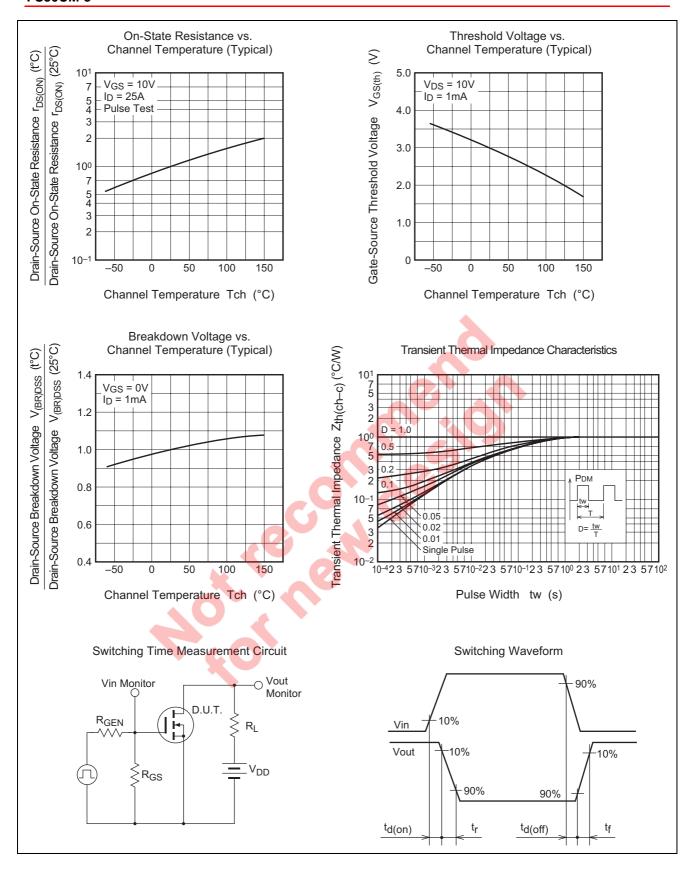
 $(Tch = 25^{\circ}C)$ 

Parameter	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	150	_	_	V	I <sub>D</sub> = 1 mA, V <sub>GS</sub> = 0 V
Gate-source leakage current	I <sub>GSS</sub>	_	_	±0.1	μΑ	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$
Drain-source leakage current	I <sub>DSS</sub>	_	_	0.1	mA	V <sub>DS</sub> = 150 V, V <sub>GS</sub> = 0 V
Gate-source threshold voltage	V <sub>GS(th)</sub>	2.0	3.0	4.0	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Drain-source on-state resistance	r <sub>DS(ON)</sub>	_	24	31	mΩ	$I_D = 25 \text{ A}, V_{GS} = 10 \text{ V}$
Drain-source on-state voltage	V <sub>DS(ON)</sub>	_	0.600	0.775	V	$I_D = 25 \text{ A}, V_{GS} = 10 \text{ V}$
Forward transfer admittance	yfs	_	55	_	S	I <sub>D</sub> = 25 A, V <sub>DS</sub> = 10 V
Input capacitance	Ciss	_	6540	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V},$
Output capacitance	Coss	_	860	_	pF	f = 1MHz
Reverse transfer capacitance	Crss	_	360	_	pF	
Turn-on delay time	t <sub>d(on)</sub>	_	95	_	ns	$V_{DD} = 80 \text{ V}, I_D = 25 \text{ A},$
Rise time	t <sub>r</sub>	_	155	_	ns	$V_{GS} = 10 \text{ V},$
Turn-off delay time	t <sub>d(off)</sub>	_	380	_	ns	$R_{GEN} = R_{GS} = 50 \Omega$
Fall time	t <sub>f</sub>		180		ns	
Source-drain voltage	$V_{SD}$		1.0	1.5	V	I <sub>S</sub> = 25 A, V <sub>GS</sub> = 0 V
Thermal resistance	R <sub>th(ch-c)</sub>	_	_	1.0	°C/W	Channel to case
Reverse recovery time	t <sub>rr</sub>	_	130		ns	$I_S = 50 \text{ A}, d_{is}/d_t = -100 \text{ A/}\mu\text{s}$
		,0	46			
40						

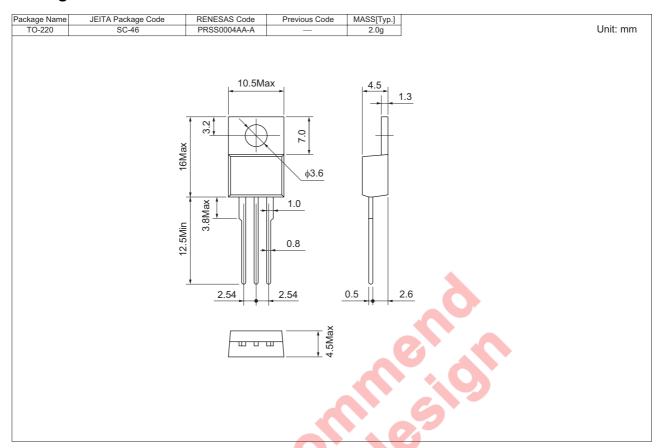
### **Performance Curves**







## **Package Dimensions**



## **Order Code**

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Straight type	Static electricity prevention bag	100	Type name	FS50UM-3
Lead form	Plastic Magazine (Tube)	50	Type name – Lead forming code	FS50UM-3-A8

Note: Please confirm the specification about the shipping in detail.

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